SHANGHAI SUNRISE ELECTRONICS CO., LTD. ES1A THRU ES1G SURFACE MOUNT SUPER FAST SWITCHING RECTIFIER

TECHNICAL SPECIFICATION

## VOLTAGE: 50 TO 400V CURRENT: 1.0A

## FEATURES

- Ideal for surface mount pick and place application
- Low profile package
- Built-in strain relief
- High surge capability
- Glass passivated chip
- Super fast recovery for high efficiency
- High temperature soldering guaranteed:
$260^{\circ} \mathrm{C} / 10 \mathrm{sec} /$ at terminal


## MECHANICAL DATA

- Terminal: Plated leads solderable per MIL-STD 202E, method 208C
- Case: Molded with UL-94 Class V-O recognized flame retardant epoxy
- Polarity: Color band denotes cathode


MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS
(Single-phase, half-wave, 60 Hz , resistive or inductive load rating at $25^{\circ} \mathrm{C}$, unless otherwise stated, for capacitive load, derate current by 20\%)

| RATINGS | SYMBOL | ES1A | ES1B | ES1C | ES1D | ES1E | ES1G | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Repetitive Peak Reverse Voltage | $\mathrm{V}_{\text {RRM }}$ | 50 | 100 | 150 | 200 | 300 | 400 | V |
| Maximum RMS Voltage | $\mathrm{V}_{\text {RMS }}$ | 35 | 70 | 105 | 140 | 210 | 280 | V |
| Maximum DC Blocking Voltage | $V_{D C}$ | 50 | 100 | 150 | 200 | 300 | 400 | V |
| Maximum Average Forward Rectified Current $\left(\mathrm{T}_{\mathrm{L}}=110^{\circ} \mathrm{C}\right)$ | $\mathrm{I}_{\text {f(AV) }}$ | 1.0 |  |  |  |  |  | A |
| Peak Forward Surge Current (8.3ms single half sine-wave superimposed on rated load) | $\mathrm{I}_{\text {FSM }}$ | 30 |  |  |  |  |  | A |
| Maximum Instantaneous Forward Voltage (at rated forward current) | $V_{\text {F }}$ | 0.95 |  |  | 1.25 |  |  | V |
| Maximum DC Reverse Current $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ <br> (at rated DC blocking voltage) $\mathrm{T}_{\mathrm{a}}=100^{\circ} \mathrm{C}$ | $I_{\text {R }}$ | $\begin{aligned} & 5.0 \\ & 200 \\ & \hline \end{aligned}$ |  |  |  |  |  | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| Maximum Reverse Recovery Time (Note 1) | trr | 35 |  |  |  |  |  | nS |
| Typical Junction Capacitance (Note 2) | $\mathrm{C}_{\mathrm{J}}$ | 10 |  |  |  |  |  | pF |
| Typical Thermal Resistance (Note 3) | $\mathrm{R}_{8}(\mathrm{ja})$ | 40 |  |  |  |  |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Storage and Operation Junction Temperature | $\mathrm{T}_{\text {STG }}, \mathrm{T}_{\mathrm{J}}$ | -50 to +150 |  |  |  |  |  | ${ }^{\circ} \mathrm{C}$ |
| Note: <br> 1. Reverse recovery condition $\mathrm{I}_{\mathrm{F}}=0.5 \mathrm{~A}, \mathrm{I}_{\mathrm{R}}=1.0 \mathrm{~A}, \mathrm{Irr}=0.25 \mathrm{~A}$. <br> 2. Measured at 1.0 MHz and applied voltage of $4.0 \mathrm{~V}_{\mathrm{dc}}$ <br> 3.Thermal resistance from junction to terminal mounted on $5 \times 5 \mathrm{~mm}$ copper pad area |  |  |  |  |  |  |  |  |

